

Tflex[™] 200 V0 Series Thermal Gap Filler

Innovative **Technology** for a **Connected** World



SOFT, FREESTANDING GAP FILLER

Tflex[™] 200 V0 is a very soft, freestanding gap filler that is more compliant than most other gap fillers. Combining good thermal conductivity of 1.1 W/mK with high conformability, this gap filler produces low thermal resistance. The alumina filler allows the product to remain a cost effective solution where moderate thermal performance is acceptable.

Naturally tacky and not requiring additional adhesive coating, the Tflex[™] 200 V0 can inhibit thermal performance. This gap filler is both electrically insulating and stable from -40°C to 160°C and meets UL 94 VO rating.

FEATURES AND BENEFITS

- Soft and compressible for low stress applications
- Naturally tacky needing no further adhesive coating
- 1.1 W/mK thermal conductivity
- Available in thicknesses from 0.010" (0.25mm) to 0.200" (5.0mm)

APPLICATIONS

- Cooling components to the chassis or frame
- High speed mass storage drives
- RDRAM memory modules
- Heat pipe thermal solutions
- Automotive engine control units
- Wireless communication hardware

global solutions: local support ...

Americas: +1.800.843.4556 Europe: +49.8031.2460.0 Asia: +86.755.2714.1166

CLV-customerservice@lairdtech.com www.lairdtech.com/thermal

TECHNOLOGIES

Tflex[™] 200 V0 Series **Thermal Gap Filler**

Innovative **Technology** for a **Connected** World

	Tflex™ 220 V0	Tflex™ 240 V0	Tflex™ 260 V0	Tflex™ 280 V0	Tflex™ 2100 V0	TEST METHOD
Construction & Composition	Reinforced ceramic filled silicone elastomer	Ceramic filled silicone elastomer				
Color	Light Gray	Light Gray	Light Gray	Light Gray	Light Gray	Visual
Thickness	0.02" (0.508mm)	0.04" (1.016mm)	0.06" (1.524mm)	0.08" (2.032mm)	0.10"(2.54mm)	
Thickness Tolerance	± 0.002" (± 0.05mm)	± 0.004" (± 0.10mm)	± 0.006" (± 0.15mm)	± 0.008" (± 0.20mm)	± 0.010" (± 0.25mm)	
Density	1.75 g/cm ³	1.73 g/cm ³	1.73 g/cm ³	1.73 g/cm ³	1.73 g/cm ³	Helium Pycnometer
Hardness	50 Shore 00	45 Shore 00	45 Shore 00	45 Shore 00	45 Shore 00	ASTM D2240
Tensile Strength	464 psi	48 psi	48 psi	48 psi	48 psi	ASTM D412
% Elongation	10.5	63.0	60.6	60.6	60.6	ASTM D412
Outgassing TML (Post Cured)	0.34%	0.34%	0.34%	0.34%	0.34%	ASTM E595
Outgassing CVCM (Post Cured)	0.10%	0.10%	0.10%	0.10%	0.10%	ASTM E595
UL Flammability Rating	94 VO	94 VO	94 VO	94 VO	94 VO	E180840
Temperature Range	-45°C to 160°C	-45°C to 160°C	-45°C to 160°C	-45°C to 160°C	-45°C to 160°C	
Thermal Conductivity	1.1 W/mK	1.1 W/mK	1.1 W/mK	1.1 W/mK	1.1 W/mK	ASTM D5470 (modified)
Total Thermal Resistance @ 10 psi @ 69KPa	0.80 °C-in²/W 5.13 °C-cm²/W	1.57 °C-in²/W 10.13 °C-cm²/W	2.05 °C-in²/W 13.23 °C-cm²/W	2.51 °C-in²/W 16.19 °C-cm²/W	2.93 °C-in²/W 18.90 °C-cm²/W	ASTM D5470 (modified)
Coefficient of Thermal Expansion	229 ppm/°C 35°C to 130°C	229 ppm/°C 35°C to 130°C	229 ppm/°C 35°C to 130°C	229 ppm/°C 35°C to 130°C	229 ppm/°C 35°C to 130°C	IPC-TM-650 2.4.24
Breakdown Voltage	12,000 Volts AC	>27,000 Volts	>27,000 Volts	>27,000 Volts	>27,000 Volts	ASTM D149
Volume Resistivity	4 x 10 ¹³ ohm-cm	4 x 10 ¹³ ohm-cm	4 x 1013 ohm-cm	4 x 10 ¹³ ohm-cm	4 x 1013 ohm-cm	ASTM D257
Dielectric Constant @ 1MHz	5.5	5.5	5.5	5.5	5.5	

STANDARD THICKNESSES

0.020" (0.51mm)	0.030" (0.76mm)	0.040" (1.02mm)	0.050" (1.27mm)				
0.060" (1.52mm)	0.070" (1.78mm)	0.080" (2.03mm)	0.090" (2.29mm)				
0.100" (2.54mm)	0.110" (2.79mm)	0.120" (3.05mm)	0.130" (3.30mm)				
0.140" (3.56mm)	0.150" (3.81mm)	0.160" (4.06mm)	0.170" (4.32mm)				
0.180" (4.57mm)	0.190" (4.83mm)	0.200" (5.08mm)					
Consult the factory for alternate thicknesses							

STANDARD SHEET SIZES

9" x 9" (229mm x 229mm) Tflex™ 200V0 may be die cut into individual shapes. Pressure sensitive adhesive is not applicable for Tflex[™] products.

REINFORCEMENT

0.020" (0.51mm) and 0.030" (0.762mm) are fiberglass reinforced.

Data for design engineer guidance only. Observed performance varies in application. Engineers are reminded to test the material in application.

THR-DS-Tflex-200V0 0710

Any information furnished by Laird Technologies, Inc. and its agents is believed to be accurate and reliable. All specifications are subject to change without notice. Responsibility for the use and application of Laird Technologies materials rests with the end user, since Laird Technologies and its agents cannot be aware of all potential uses. Laird Technologies maters as to the fitness, merchantability or suitability of any Laird Technologies materials rests with the end user, since Laird Technologies shall not be liable for incidental or consequential damages of any kind. All Laird Technologies products are sold pursuant to the Laird Technologies Terms and Conditions of sale in effect from time to time, a cony of which will be furnished upon request. Q. Ocypyint 21010 Laird Technologies, Inc. All Rights Reserved, Laird, Laird Technologies, Logo, and other marks are trade marks or registered trade marks of Laird Technologies, inc. or an affiliate company thereof. Other product or service names may be the property of third parties. Nothing herein provides a license under any Laird Technologies or any third party intellectual property rights.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Thermal Interface Products category:

Click to view products by Laird Connectivity manufacturer:

Other Similar products are found below :

 7721-9PPS
 FGN80-2
 PFM-172-60
 A-40
 174-9-230P
 9601-7
 5300AC 1.500G
 08133
 V6622C
 TVQF-1225-07S
 TP0001
 4860
 SC80-W2

 V6516C
 A17713-06
 A17713-05
 A17653-05
 A17690-06
 A17775-03
 A17690-05
 A17653-02
 A17689-02
 A17690-04
 A17775-05
 A17775

 06
 A17690-08
 A17690-02
 A17689-06
 A17653-06
 A17690-12
 A17653-03
 A17536-02
 A17689-03
 A17536-10
 A17752-13
 A17752-04

 A17752-07
 A17634-12
 19-36565-0001-1
 A17752-09
 22000-001A
 A17752-20
 A17752-16
 A17752-12
 A17653-04
 A17634-10
 A17634-09

 A17634-07
 A17633-20
 A17633-07
 A17633-07
 A17633-07
 A17633-07